Harvatek Surface Mount LED Data Sheet
T3214DND-75P-000812

DISCLAIMER

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Life Support Policy

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Product Specifications

Item	Specification	Material	Quantity
Luminous Intensity(Iv)	Min 76.6lm Max113.6lm @75mA / T_s= 25℃;Tolerance: ± 10%		
Correlated Color Temperature	Refer to page 6~8 @75mA/ T_S= 25℃;Tolerance: ± 250K		
Vf	11.91~14.07V (0.24V/bin) @75mA/ T_S= 25℃;Tolerance: ± 0.05V		
Color Rendering Index (CRI)	CRI ≧80 @75mA/ Ts=25℃		
Resin	Yellow	Silicon Resin	
Carrier tape	EIA 481-1A specs	Conductive black tape	2K/REEL
Reel	EIA 481-1A specs	Conductive black	2K/REEL
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, CIE and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

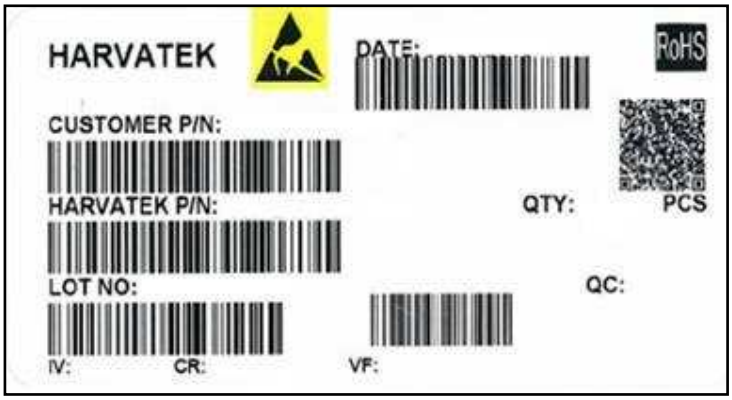
※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection

The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Label Specifications



■Harvatek P/N:

T 321 4 DND- 75P- 0008 12

Product	Dice	Current	Taping
LF	4: four	75mA	1. Taping style 2. Q'ty

Package	Color	Series Number
3.0(L)x3.0(W)x0.52(H) mm	DND: White CRI>80	0001~ZZZZ

■ Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2

Code 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code	2010-A 2011-B 2012-C 2013-D . .	1:Jan. 2:Feb. .... A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

Specifications Range

■Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
White	TC2	76.6-82 lm
	TD2	82-87.4 lm
	UA1	87.4-93.5 lm
	UB1	93.5-99.6 lm
	UC2	99.6-106.6 lm
	UD2	106.6-113.6 lm

Note: It maintains a tolerance of ±10% on Luminous Intensity

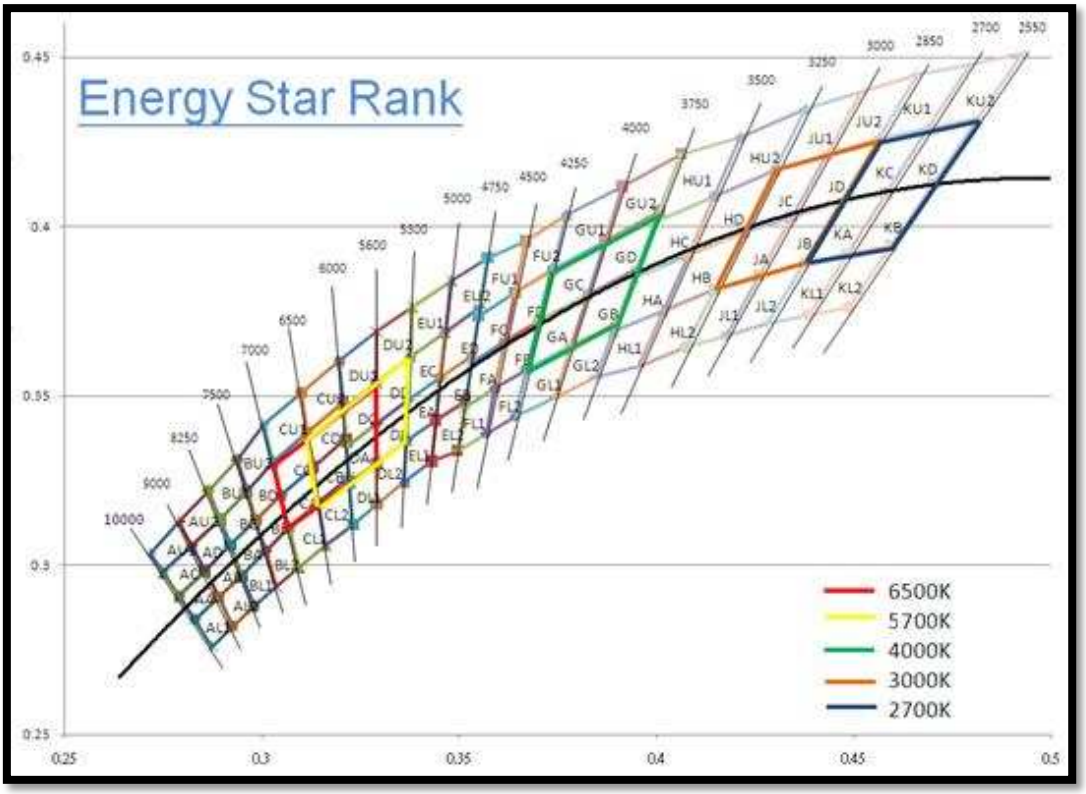
■Color Bin:

AA	0.283	0.284	BA	0.295	0.297	CA	0.3068	0.3113	DA	0.3222	0.3243	EA	0.3366	0.3369
	0.279	0.291		0.292	0.306		0.3048	0.3207		0.3215	0.335		0.3371	0.349
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3427
	0.283	0.284		0.295	0.297		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
AB	0.289	0.2905	BB	0.3009	0.3042	CB	0.3144	0.3186	DB	0.329	0.33	EB	0.344	0.3427
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.292	0.306		0.3048	0.3207		0.3213	0.3373		0.3371	0.349		0.3533	0.362
	0.295	0.297		0.3068	0.3113		0.3221	0.3261		0.3366	0.3369		0.3515	0.3487
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3427
AC	0.279	0.291	BC	0.292	0.306	CC	0.3048	0.3207	DC	0.3215	0.335	EC	0.3371	0.349
	0.275	0.298		0.2895	0.3135		0.3028	0.3304		0.3207	0.3462		0.3376	0.3616
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.279	0.291		0.292	0.306		0.3048	0.3207		0.3215	0.335		0.3371	0.349
AD	0.2855	0.2985	BD	0.2984	0.3133	CD	0.313	0.329	DD	0.329	0.3417	ED	0.3451	0.3554
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
	0.2895	0.3135		0.3028	0.3304		0.3205	0.3481		0.3376	0.3616		0.3551	0.376
	0.292	0.306		0.3048	0.3207		0.3213	0.3373		0.3371	0.349		0.3533	0.362
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
AL1	0.2874	0.276	BL1	0.298	0.288	CL1	0.3093	0.2993	DL1	0.3231	0.312	EL1	0.3361	0.3245
	0.283	0.284		0.295	0.297		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.2925	0.282		0.3037	0.2937		0.3161	0.3059		0.329	0.318		0.3429	0.3307
	0.2874	0.276		0.298	0.288		0.3093	0.2993		0.3231	0.312		0.3361	0.3245
AL2	0.2925	0.282	BL2	0.3037	0.2937	CL2	0.3161	0.3059	DL2	0.329	0.318	EL2	0.3429	0.3307
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.295	0.297		0.3068	0.3113		0.3221	0.3261		0.3366	0.3369		0.3515	0.3487
	0.298	0.288		0.3093	0.2993		0.3231	0.312		0.3361	0.3245		0.3495	0.3339
	0.2925	0.282		0.3037	0.2937		0.3161	0.3059		0.329	0.318		0.3429	0.3307
AU1	0.275	0.298	BU1	0.2895	0.3135	CU1	0.3028	0.3304	DU1	0.3207	0.3462	EU1	0.3376	0.3616
	0.2718	0.3036		0.2864	0.3221		0.3005	0.3415		0.3196	0.3602		0.3381	0.3762
	0.279	0.313		0.2937	0.3312		0.3099	0.3509		0.329	0.369		0.348	0.384
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
	0.275	0.298		0.2895	0.3135		0.3028	0.3304		0.3207	0.3462		0.3376	0.3616
AU2	0.28225	0.30575	BU2	0.2962	0.322	CU2	0.3115	0.3391	DU2	0.329	0.3538	EU2	0.3463	0.3687
	0.279	0.313		0.2937	0.3312		0.3099	0.3509		0.329	0.369		0.348	0.384
	0.2864	0.3221		0.3005	0.3415		0.3196	0.3602		0.3381	0.3762		0.3571	0.3907
	0.2895	0.3135		0.3028	0.3304		0.3205	0.3481		0.3376	0.3616		0.3551	0.376
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687

FA	0.3512	0.3465	GA	0.367	0.3578	HA	0.3889	0.369	JA	0.4147	0.3814	KA	0.4373	0.3893
	0.353	0.3597		0.3702	0.3722		0.3941	0.3848		0.4221	0.3984		0.4465	0.4071
	0.3615	0.3659		0.3825	0.3798		0.408	0.3916		0.4342	0.4028		0.4582	0.4099
	0.359	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
	0.3512	0.3465		0.367	0.3578		0.3889	0.369		0.4147	0.3814		0.4373	0.3893
FB	0.359	0.3521	GB	0.3783	0.3646	HB	0.4017	0.3751	JB	0.4259	0.3853	KB	0.4483	0.3919
	0.3615	0.3659		0.3825	0.3798		0.408	0.3916		0.4342	0.4028		0.4582	0.4099
	0.3702	0.3722		0.395	0.3875		0.4221	0.3984		0.4465	0.4071		0.47	0.4126
	0.367	0.3578		0.3898	0.3716		0.4147	0.3814		0.4373	0.3893		0.4593	0.3944
	0.359	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
FC	0.353	0.3597	GC	0.3702	0.3722	HC	0.3941	0.3848	JC	0.4221	0.3984	KC	0.4465	0.4071
	0.3548	0.3736		0.3736	0.3874		0.3996	0.4015		0.4299	0.4165		0.4562	0.426
	0.3641	0.3804		0.3869	0.3958		0.4146	0.4089		0.443	0.4212		0.4687	0.4289
	0.3615	0.3659		0.3825	0.3798		0.408	0.3916		0.4342	0.4028		0.4582	0.4099
	0.353	0.3597		0.3702	0.3722		0.3941	0.3848		0.4221	0.3984		0.4465	0.4071
FD	0.3615	0.3659	GD	0.3825	0.3798	HD	0.408	0.3916	JD	0.4342	0.4028	KD	0.4582	0.4099
	0.3641	0.3804		0.3869	0.3958		0.4146	0.4089		0.443	0.4212		0.4687	0.4289
	0.3736	0.3874		0.4006	0.4044		0.4299	0.4165		0.4562	0.426		0.4813	0.4319
	0.3702	0.3722		0.395	0.3875		0.4221	0.3984		0.4465	0.4071		0.47	0.4126
	0.3615	0.3659		0.3825	0.3798		0.408	0.3916		0.4342	0.4028		0.4582	0.4099
FL1	0.3495	0.3339	GL1	0.364	0.344	HL1	0.3846	0.3557	JL1	0.4073	0.3644	KL1	0.4281	0.3715
	0.3512	0.3465		0.367	0.3578		0.3889	0.369		0.4147	0.3814		0.4373	0.3893
	0.359	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
	0.3567	0.3389		0.3741	0.3494		0.3954	0.3586		0.4176	0.3678		0.4384	0.3739
	0.3495	0.3339		0.364	0.344		0.3846	0.3557		0.4073	0.3644		0.4281	0.3715
FL2	0.3567	0.3389	GL2	0.3741	0.3494	HL2	0.3954	0.3586	JL2	0.4176	0.3678	KL2	0.4384	0.3739
	0.359	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
	0.367	0.3578		0.3898	0.3716		0.4147	0.3814		0.4373	0.3893		0.4593	0.3944
	0.364	0.344		0.3846	0.3557		0.4073	0.3644		0.4281	0.3715		0.4486	0.3762
	0.3567	0.3389		0.3741	0.3494		0.3954	0.3586		0.4176	0.3678		0.4384	0.3739
FU1	0.3548	0.3736	GU1	0.3736	0.3874	HU1	0.3996	0.4015	JU1	0.4299	0.4165	KU1	0.4562	0.426
	0.3571	0.3907		0.3771	0.4034		0.4062	0.4213		0.4377	0.4346		0.4659	0.4449
	0.3668	0.3957		0.3913	0.4118		0.4212	0.4262		0.4518	0.4396		0.4792	0.4479
	0.3641	0.3804		0.3869	0.3958		0.4146	0.4089		0.443	0.4212		0.4687	0.4289
	0.3548	0.3736		0.3736	0.3874		0.3996	0.4015		0.4299	0.4165		0.4562	0.426
FU2	0.3641	0.3804	GU2	0.3869	0.3958	HU2	0.4146	0.4089	JU2	0.443	0.4212	KU2	0.4687	0.4289
	0.3668	0.3957		0.3913	0.4118		0.4212	0.4262		0.4518	0.4396		0.4792	0.4479
	0.3771	0.4034		0.4062	0.4213		0.4377	0.4346		0.4659	0.4449		0.4926	0.4512
	0.3736	0.3874		0.4006	0.4044		0.4299	0.4165		0.4562	0.426		0.4813	0.4319
	0.3641	0.3804		0.3869	0.3958		0.4146	0.4089		0.443	0.4212		0.4687	0.4289

Note: It maintains a tolerance of x,y ±0.01

■Correlated Color Temperature:



■Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
White	QT	11.91-12.15V
	QU	12.15-12.39V
	QV	12.39-12.63V
	QW	12.63-12.87V
	QX	12.87-13.11V
	QY	13.11-13.35V
	QZ	13.35-13.59V
	RA	13.59-13.83V
	RB	13.83-14.07V

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

Product Features

Electro-Optical Characteristics

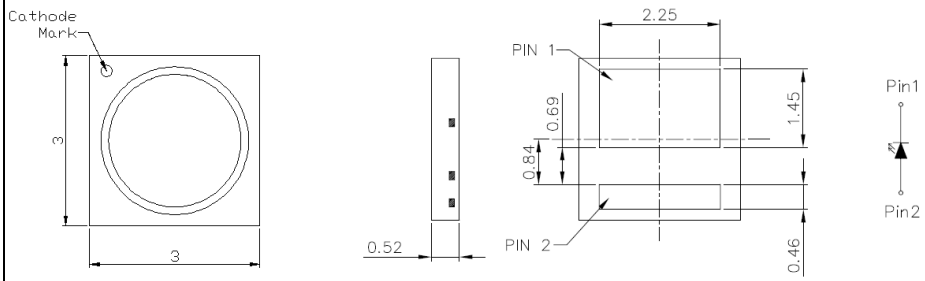
($T_{Soldering}$, 25 °C)

Series	Emitting Color	Material	V_F(V)		Correlated Color Temperature			I_V(lm)	Viewing Angle
			typ	max	min	typ	max	Typical	$2\theta\frac{1}{2}$
T3214DND-75	Cold White	InGaN	12.63	14.07	5600	6250	7000	92	120
T3214DND-75	Cold White	InGaN	12.63	14.07	5300	5700	6500	93	120
T3214DND-75	Nature White	InGaN	12.63	14.07	3750	4000	4250	93	120
T3214DND-75	Warm White	InGaN	12.63	14.07	2850	3000	3250	83	120
T3214DND-75	Warm White	InGaN	12.63	14.07	2550	2700	2850	80	120
ITEM	Symbol		TYP			MAX		Unit	
Thermal Resistance	RthJ-S		12			18		K/W	

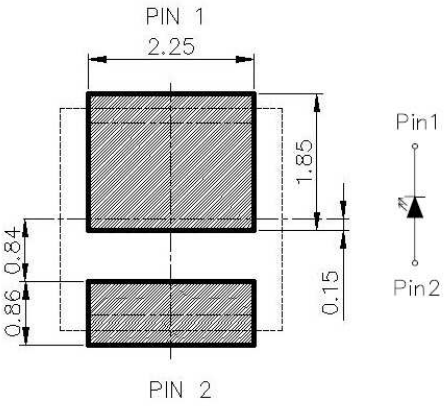
Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)

Outline Dim.



Soldering Pattern



Soldering terminals may shift in the x, y direction.

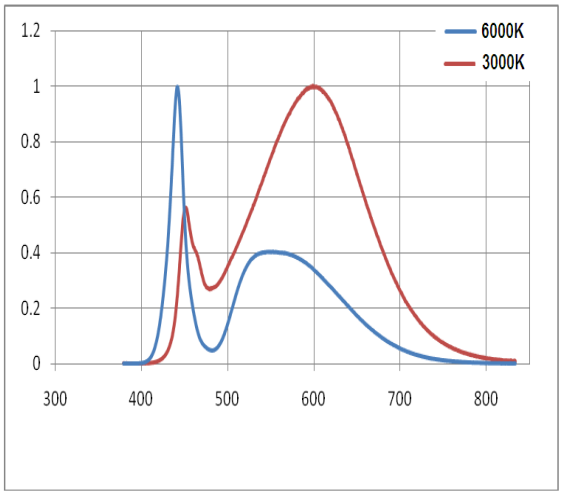
Absolute Maximum Ratings

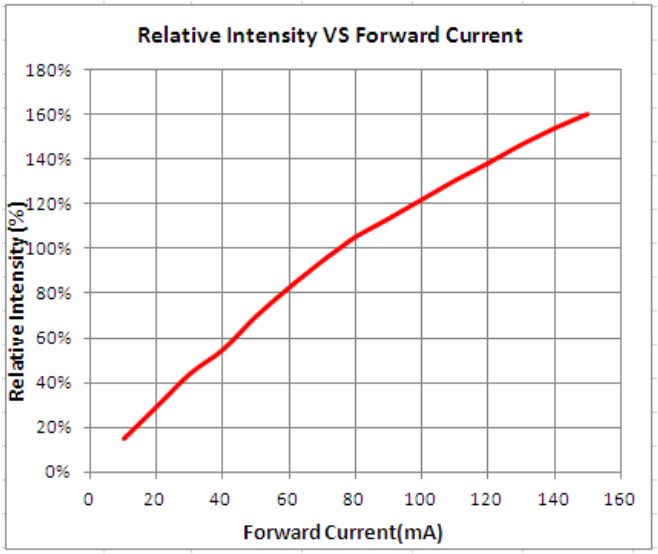
($T_{Soldering}$ 25 °C)

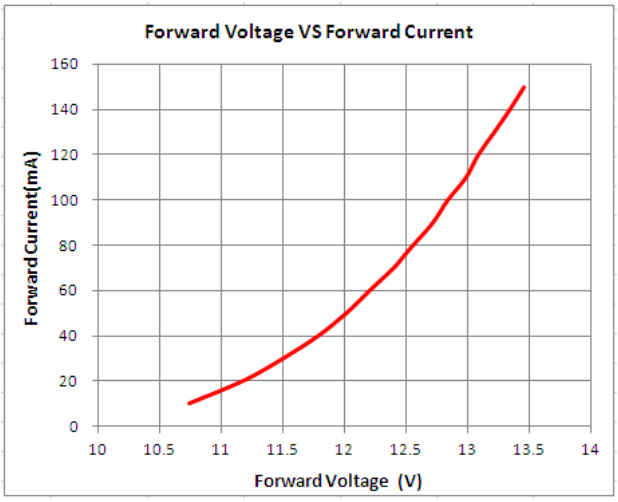
Series	P_D (W)	I_F (mA)	I_{FP} (mA)*	Tj (°C)	T_{OP} (°C)	T_{ST} (°C)
Color	Power Dissipation	Forward Current	Peak Forward Current	Junction Temperature	Operating Temperature	Storage Temperature
Warm White	1	90	150	110	-40~+85	-40~+100
Neutral White	1	90	150	110	-40~+85	-40~+100
Cold White	1	90	150	110	-40~+85	-40~+100

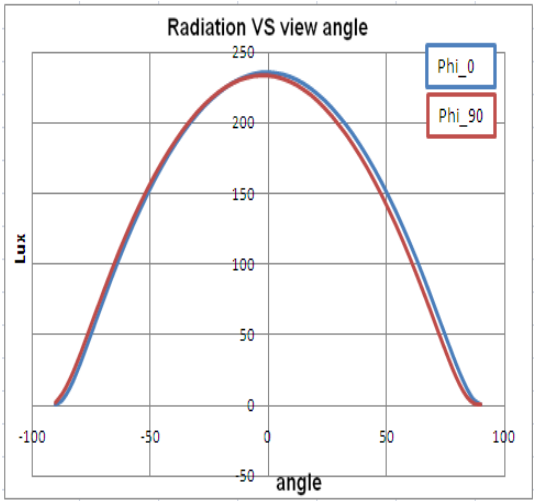
* Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

Characteristics of T3214DND

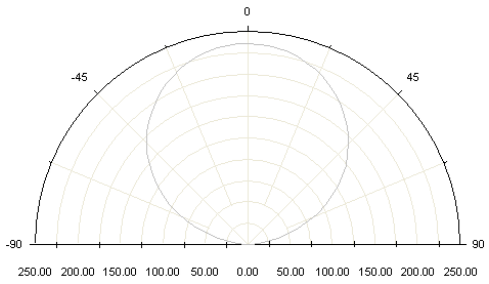




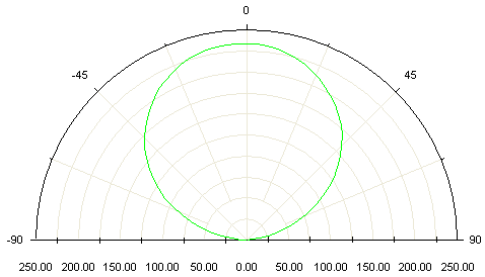


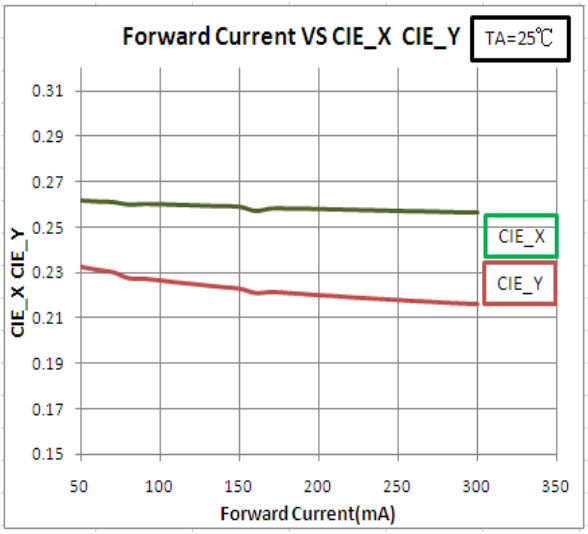


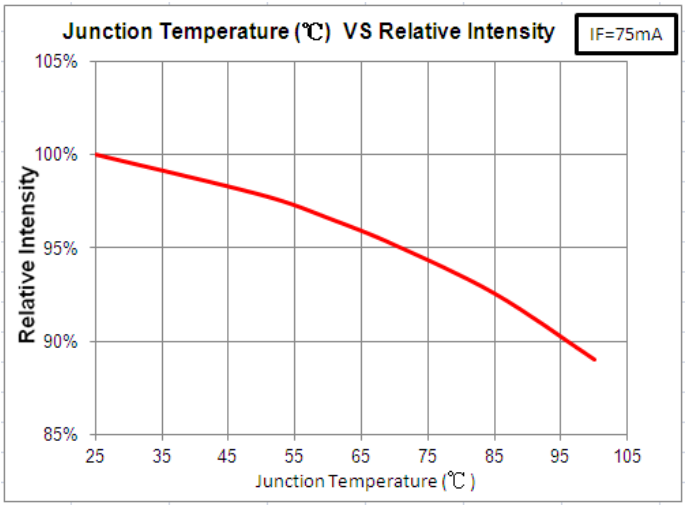
Directive Characteristics

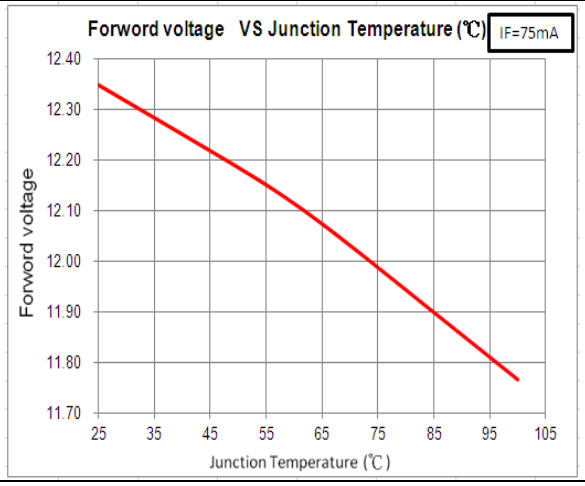


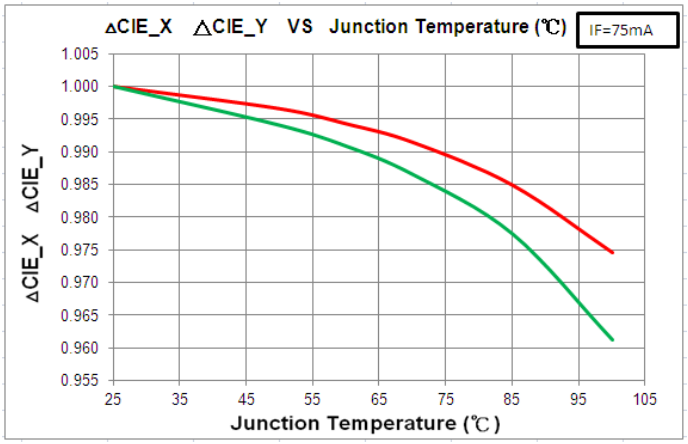
Directive Characteristics

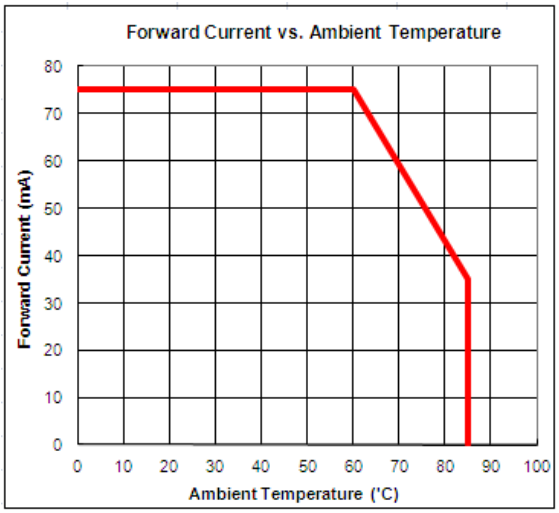



Forward Current VS CIE_X CIE_Y
TA=25℃
CIE_X
CIE_Y
CIE_X CIE_Y
Forward Current(mA)


Junction Temperature (℃) VS Relative Intensity
IF=75mA
Relative Intensity
Junction Temperature (℃)


Forword voltage VS Junction Temperature (℃)
IF=75mA
Forword voltage
Junction Temperature (℃)


ΔCIE_X ΔCIE_Y VS Junction Temperature (℃)
IF=75mA
ΔCIE_X ΔCIE_Y
Junction Temperature (℃)

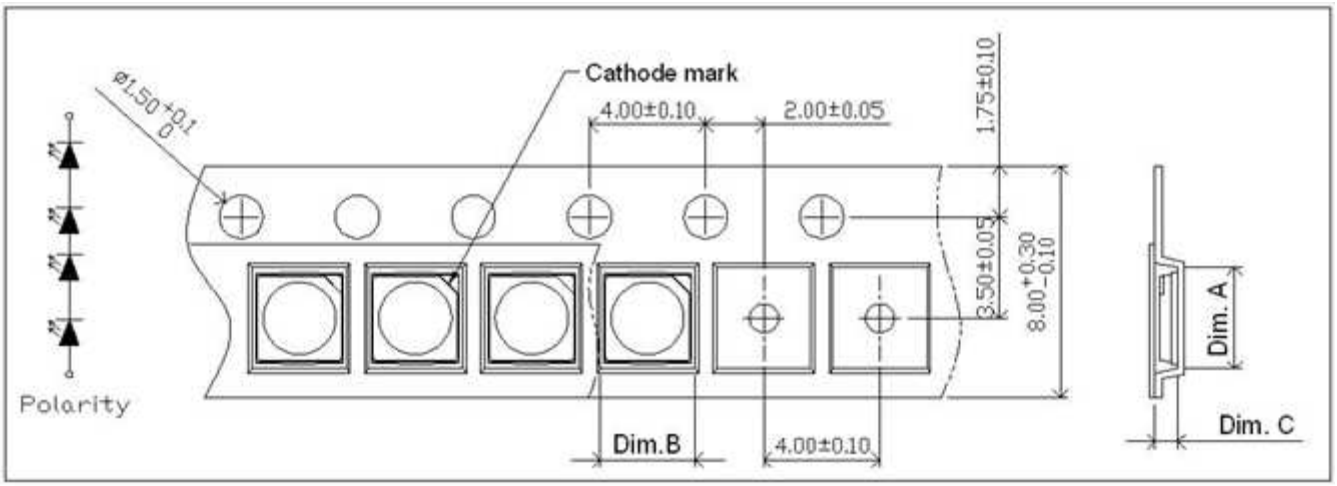

Forward Current vs. Ambient Temperature
Forward Current (mA)
Ambient Temperature ('C)

Precaution for Use

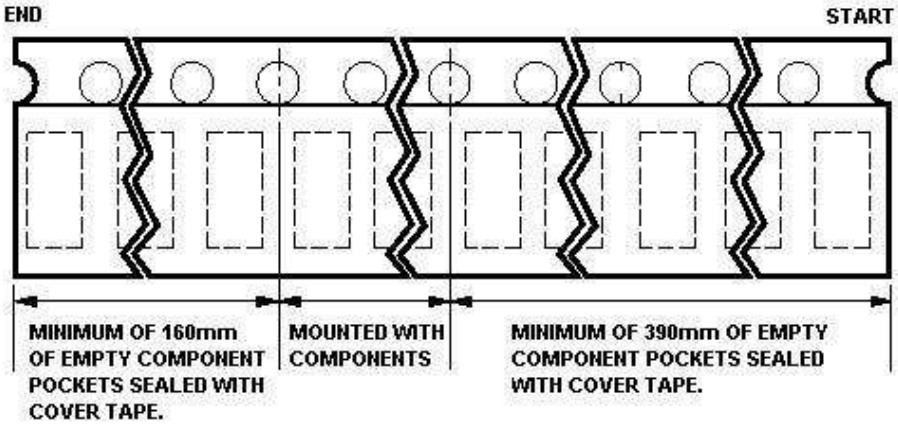
1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within seven days after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

Packaging

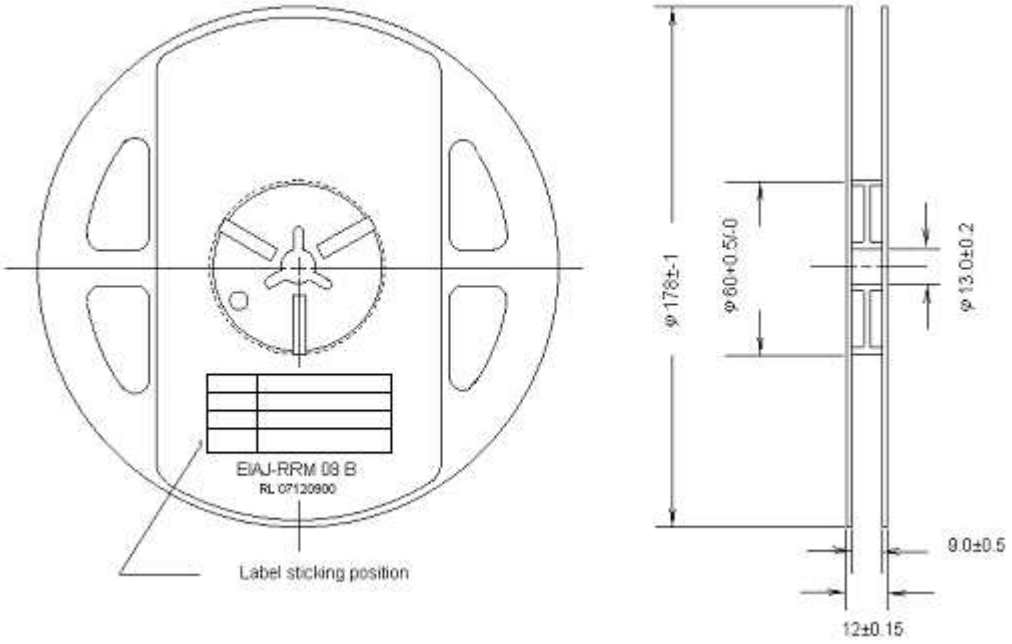
Tape Dimension



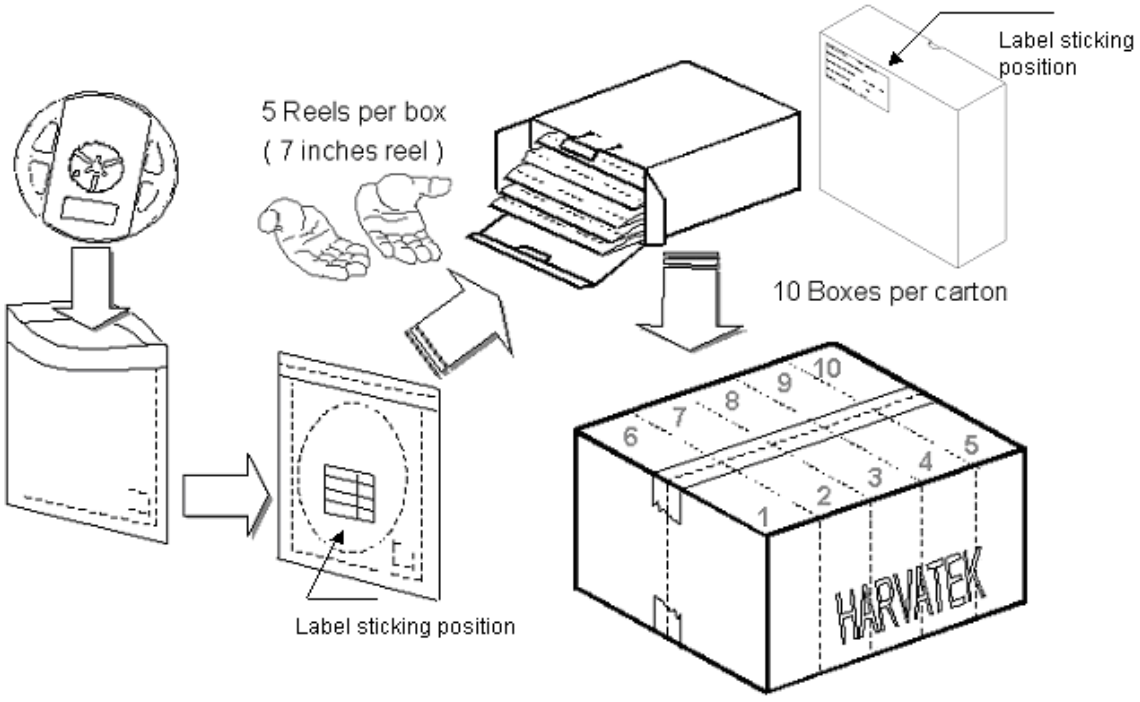
Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.49±0.1	3.26±0.1	0.78±0.1	2K



Reel Dimension



Packing



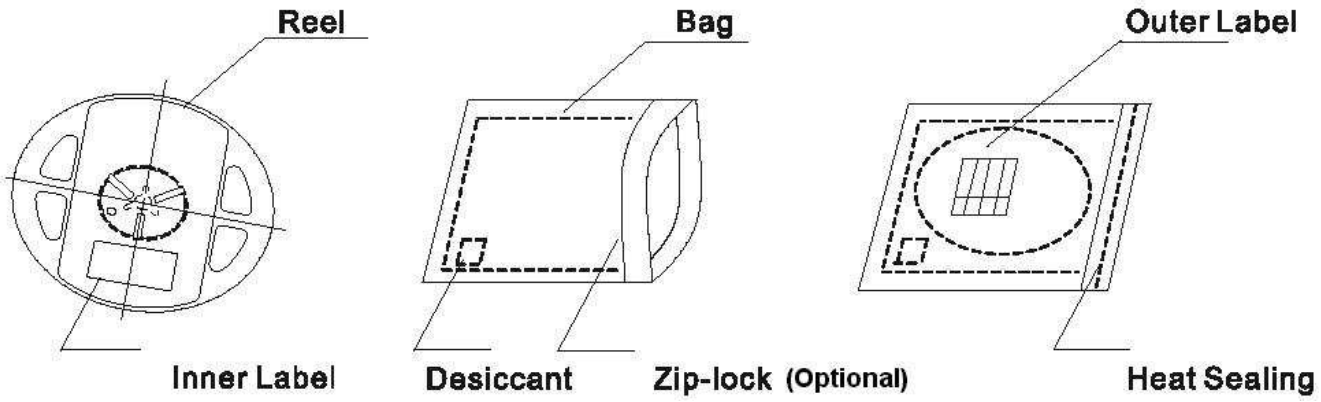
5 boxes per carton is available depending on shipment quantity.

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 72 hours. The conditions are as followings:

1. 60±3℃×(12~24hrs)and<5%RH, taped reel type.
2. 100±3℃×(45min~1hr), bulk type.
3. 130±3℃×(15min~30min), bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

Handling of Silicone Resin LEDs

Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible.

Sharp objects of all types should not be used to pierce the sealing compound.

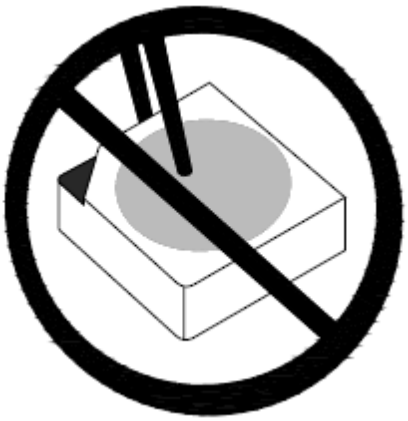


Figure 1

In general, LEDs should only be handled from the side. By the way ,this also applies to LEDs without a silicone sealant, since the surface can also become scratched.

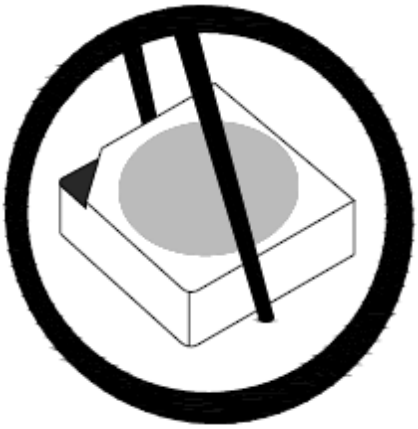


Figure 2

When populating boards in SMT production, there are basically no restrictions regarding the from of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.

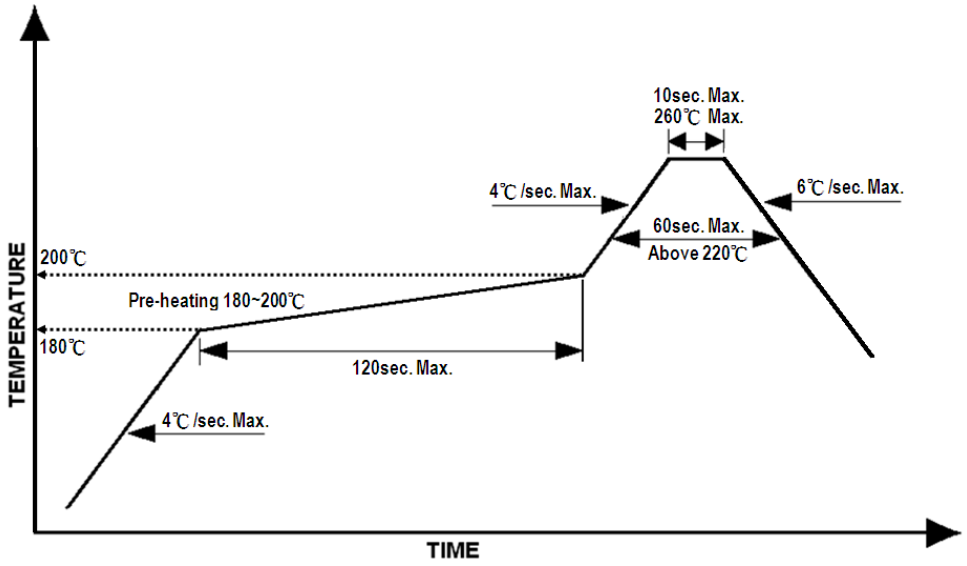
This is assured by choosing a pick and place nozzle which is large than LEDs reflector area.

Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 220 ^{O}C ,60 sec.
2. Peak temp.:260 ^{O}CMax.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 ^{O}C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50^{o}C x 30sec. or <30^{o}C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^{O}C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
1.0	NEW	09/04/2013	-
1.1	Update Rth	10/02/2013	9